

**Amendments to the Specification:**

Please replace the paragraph beginning at page 31, line 4, with the following amended paragraph:

Further in ~~[[thus]]~~ this embodiment columnar spacer 172 is formed, as shown in Fig. 7, on the active matrix substrate which went through the above described processes. At the same time, a ~~protective~~ protection film ~~[[173]]~~ 174 which protects side face of the terminal section 182 of the connection wiring 183 is formed with the formation ~~[[if]]~~ of the columnar spacer 172. The material of the columnar spacer 172 is not limited, in particular, and they may be formed by using, for example, "NN700" of JSR Co., and after the material is coated by a spinner, a prescribed pattern is formed by exposure and development. The pattern is then heated and cured at 150 to 200°C in a clean ~~oven. Or like~~ oven or the like.